

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor:	John H. Magerlein et al.	Date:	November 14, 2003
Application No.:		Examiner:	
Filed:	Herewith	Art Unit:	
Title:	Method of Manufacture of Silicon Based Package and Devices Manufactured Thereby	Attorney:	Graham S. Jones, II 42 Barnard Avenue Poughkeepsie, NY 12601-5023

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria VS, 22313-1450

Sir:

Pursuant to the duty of disclosure set forth in 37 CFR 1.56, and further pursuant to 37 CFR 1.97 and 37 CFR 1.98, Applicants hereby respectfully submit copies of the following prior patents and publications as listed on Form PTO-1449, attached hereto.

Respectfully submitted,
John H. Magerlein et al.

By:


Graham S. Jones, II, Attorney
Registration No. 20,429
Telephone: 845-473-9118
Facsimile: 845-485-9399

Enclosures: Form 1449 with references attached

PAGE 1 OF 1

FORM PTO-1449 (M dified)		Attorney Docket Number: FIS9-2000-0412-US2	Serial Number
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT		APPLICANT: John H. Magerlein et al.	
(Use several sheets if necessary)		Filing Date:	Group:

Examiner Initials	Document Number	Issued Date	Name	Class	Subclass	FILING DATE (IF APPRO.)
AA	5,258,236	2 Nov. 1993	Arjavalingham	428	626	
AB	5,497,545	12 Mar. 1996	Watanabe	29	830	
AC	5,654,590	5 Aug. 1997	Kuramochi	257	778	
AD	5,965,933	12 Oct. 1999	Young	257	621	
AE	6,036,809	14 Mar. 2000	Kelly	156	247	
AF	6,066,562	23 May 2000	Oshima	438	691	
AG	6,184,060	6 Feb. 2001	Siniaguine	438	106	
AH	6,187,418	13 Feb. 2001	Fasano	428	210	

	Published Application No.	Publication Date	Name	Class	Subclass	
AI	US2002/0086519A1	4 Jul. 2002	Houston	438	622	

FOREIGN PATENT DOCUMENTS

	Document Number	Date	Country	Class	Subclass	Translation
						Yes
AJ						No

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

AK	Matsuo et al. "Silicon Interposer Technology for High-density Package" , Session 36, Afternoon, Wednesday, May 24, 2000, at Caesar's Palace, Las Vegas, NV, Proceedings of IEEE Electronic Components and Technology Conference, IEEE, ISBN 0780359089, 4 pages (2000)
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EXAMINER

DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.